CSM12D

EDUCATIONAL MODULE FOR FREESCALE MC9S12XDT512 and MC9S12DT256 MCU's

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REVISION HISTORY

Date Rev Comments

July 26, 2005	Α	Initial Release
March 7, 2006	В	Updated document format. Updated IO header table.

CAUTIONARY NOTES

1) Electrostatic Discharge (ESD) prevention measures should be used when handling this product. ESD damage is not a warranty repair item.

- Axiom Manufacturing does not assume any liability arising out of the application or use of any product or circuit described herein; neither does it convey any license under patent rights or the rights of others.
- 3) EMC Information on the CSM12D board:
 - a) This product as shipped from the factory with associated power supplies and cables, has been verified to meet with requirements of CE and the FCC as a CLASS B product.
 - b) This product is designed and intended for use as a development platform for hardware or software in an educational or professional laboratory.
 - c) In a domestic environment, this product may cause radio interference in which case the user may be required to take adequate prevention measures.
 - d) Attaching additional wiring to this product or modifying the products operation from the factory default as shipped may effect its performance and cause interference with nearby electronic equipment. If such interference is detected, suitable mitigating measures should be taken.

TERMINOLOGY

This development module uses option select jumpers to configure default board operation. Terminology for application of the option jumpers is as follows:

Jumper – a plastic shunt that connects 2 terminals electrically

Jumper on, in, or installed - jumper is installed such that 2 pins are connected together

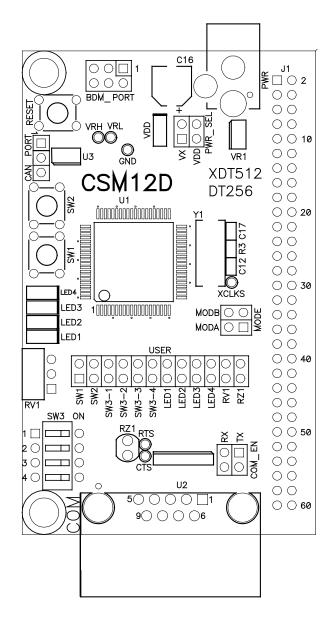
Jumper off, out, or idle - jumper is installed on 1 pin only. It is recommended that jumpers be idled by installing on 1 pin so they will not be lost.

FEATURES

The CSM12D is an educational development module supporting the Freescale MC9S12XDT512 or the MC9S12DP256 MCU's. This module is designed to be used with the MCU Project Board-2 Student Learning Kit (MCUSLKA) or as a stand-alone board. Application development is quick and easy with the included software tools, and examples. The module may be programmed from the on-board BDM header or from the integrated USB-ML12 BDM on the MCUSLKA. A single 60-pin connector directly interfaces to the MCUSLKA.

Features:

- MC9S12XDT512 MCU, 80 LQFP (-100)
 - X-GATE Co-Processor
 - 512 KB Flash EEPROM
 - 4KB EEPROM
 - 20 KB SRAM
- MC9S12DT256 MCU, 80 LQFP (-200)
 - 256 KB Flash EEPROM
 - 4KB EEPROM
 - 12 KB RAM
 - SAE J1850 Byte Data Link Controller
- 8-ch, 10-bit, ATD w/ external trigger
- 8-bit Enhanced Capture Timer with IC, OC, and Pulse Accumulate capabilities
- 7-ch, 8-bit PWM
- 9 KBI inputs
- 58 GPIO
- 3 CAN Channels
 - CAN 2.0 A/B PHY w/ 3-pos header
- 2 SCI Channels
 - RS-232 transceiver w/ 2 DB9 connectors
- 3 SPI Channels
- 1 IIC Channel
- 4 MHz Clock Oscillator
- Low Voltage Reset Supervisor
- Power Input Selection Header
 - On-board 5V regulator
 - Power Input from MCU I/O Connector
 - Power Output from MCU I/O Connector
- User Components Provided
 - 1 DIP Switch, 4-pos
 - 3 Push Button Switches: 2 User, RESET
 - 5 LED Indicators: 4 User, +5V
- Jumpers
 - USER EN
 - PWR SEL
 - COM EN
- Connectors
 - 1 60-pos pin-header providing access to MCU IO signals
 - 2.0mm barrel connector power input
 - 6-pin BDM interface connector
 - 3-pos CAN connector
 - 2 DB9 COM connectors



Supplied with DB9 Serial Cable, Power Supply, Documentation (CD), and Manual

Specifications:

Module Size 3.5" x 2.5"

Power Input: +9V typical, +6V to +20V

REFERENCES

Reference documents are provided on the support CD in Acrobat Reader format.

CSM12D_UG_A.pdf CSM12D User Guide (this document)

9S12XDP512V2_ZIP.zip MC9S12XDP512 Device User Guide 9S12DT256_ZIP.zip MC9S12DT256 Device User Guide

AN2546.pdf S12X Load RAM and Execute (LRAE) Program Applica-

tion Note

AN2615.pdf HC(S)12 and S12X Family Compatibility

AN2685.pdf How to Configure and Use the XGATE on S12X Devices

AN2708.pdf An Introduction to the External Bus Interface on the

HC(S)12X

GETTING STARTED

The module ships from the factor with a small demonstration pre-programmed into flash memory. This program will print a welcome message out the COM connector and flash the LED's. The Quick Start Guide included in the module kit will describe the steps necessary to configure board for operation.

Programming the module requires the use of a BDM such as P&E Microcomputer System's BDM Multilink. There is no BDM included in the kit when shipped. This is a separate item. The included CodeWarrior IDE from Metrowerks also supports programming the module. Refer to the CodeWarrior quick-start and user manual for further details.

OPERATING MODES

The CSM12D board operates in two operating modes: Run Mode, or Debug Mode. Run Mode allows user application code to execute from Power-On or Reset. Debug Mode supports the development and debug of application code. See the related sections below for quickly starting the board in the desired operation mode.

RUN MODE

Run mode allows user application to execute when power is applied to the board. Use the following settings to configure the CSM12D board for RUN Mode to get started quickly.

1. Connect a COM port serial communication cable between board and host PC if needed for the application. Launch supporting host communication software as needed.

- 2. Connect auxiliary equipment to board as required by application.
- 3. Configure the board option jumpers for run mode.

Table 1: Run Mode Setup

PWR_SEL	PWR (pos 2)
COM_EN	As Required
USER	As Required

- 4. Apply power to the board.
- 5. The programmed application should begin to execute.

Debug Mode

Debug Mode supports application development and debug. Debug mode is available to the user through the integrated USB-BDM on the MCUSLKA or an external HC(S)12 BDM cable. Refer to the MCUSLKA User Guide for details on using the integrated USB-BDM. A 6-pin BDM interface header (BDM_PORT) supports the use of an external HC(S)12 BDM cable. The steps below describe using an external HC(S)12 BDM cable to access DEBUG mode.

- 1. Install and launch P&E PKG12Z tool set, CodeWarrior Development Studio, or other software capable of communicating with the HC(S)12 MCU.
- 2. Connect the HC(S)12 BDM cable to the BDM_PORT header.
- 3. Connect COM port serial communication cable between board and host PC if needed by the application. Launch supporting host communication software as needed.
- 4. Connect auxiliary equipment to the module if needed by the application.
- 5. Configure the board option jumpers for DEBUG mode.

Table 2: BDM Mode Setup

PWR_SEL	PWR
COM_EN	As Required
USER	As Required

- 6. Connect the supplied USB cable between an available USB port on the host PC and the USB connector on the board.
- 7. Hosting development software will establish DEBUG communication.

DEVELOPMENT SUPPORT

Software Development

Software development will require the use of an HC(S)12 assembler or compiler and a host PC operating a debug interface. The assembler should also support the HC(S)12 X-Gate command set if attempting application development on the MC9S12XDT512 MCU. Supplied with this board is the CodeWarrior Development Studio along with the Axiom IDE for Windows for debugging and flash programming.

MEMORY MAP

The CSM12D is designed to support either of 2 different parts from the MC9S12D family of MCU's: the MC9S12XDT512 or the MC9S12DT256. This section shows the default memory map for both MCU's immediately out of reset. Refer to the Device User Guide for the specific MCU installed for further details.

MC9S12XDT512

Table 3: XDT512 Memory Map

0x0000 -	Registers	2 K	
0x07FF	_	bytes	
0x0800 -	Paged EEPROM	4K	4 – 1Kb pages
0x0BFF		bytes	
0x0C00 -	Fixed EEPROM	1K	
0x0FFF		bytes	
0x1000 -	Paged RAM	20 KB	5 – 4Kb pages
0x1FFF			
0x2000 -	Fixed RAM	8K	
0x3FFF		bytes	
0x4000 -	FIXED FLASH	16 KB	1K, 2K, 4K, 8K
0x7FFF			Protected Boot Sector
0x8000 -	Paged FLASH	512K	32 – 16Kb pages
0xBFFF		bytes	
0xC000 -	FIXED FLASH	16 KB	2K, 4K, 8K, 16K
0xFEFF			Protected Boot Sector
0xFF00 -	Vectors	255	
0xFFFF		bits	

MC9S12DT256

Table 4: DT256 Memory Map

0x0000 -	Registers	1K	Mappable to any 2K block in the
0x03FF	•	bytes	first 32K
0x0400 -	EEPROM	4K	Mappable to any 4K block. Bottom
0x0FFF		bytes	1K used by Registers out of reset
0x1000 -	RAM	12K	Mappable to any 16K block and
0x3FFF		bytes	alignable top or bottom
0x4000 -	Fixed FLASH	16K	Dependant on state of ROMHM bit
0x7FFF		bytes	
0x8000 -	Paged FLASH	256K	16 – 16K pages
0xBFFF		bytes	
0xC000 -	Fixed Flash	16K	
0xFEFF		bytes	
0xFF00 -	Vectors	256	BDM if active
0xFFFF		bytes	

NOTE: The bottom 1K of EEPROM is covered by Registers out of reset.

BDM_PORT Header

A 6-pin BDM port header allows connection of a HC(S)12 compatible BDM cable for application development. Refer to the BDM cable documentation for details on use of the BDM cable with this module.

Figure 1: BDM_PORT

MODC/BKGD	1	2	GND	See the HC12 Reference Manual for
	3	4	RESET*	complete DEBUG documentation
	5	6	VDD	

Expanded Mode Operation

If a 9S12XDT512 MCU is installed on the CSM12D module, expanded mode operation is not supported or available to the user. The data bus is not bonded out on the MCU. Operational modes include only single-chip mode.

If a 9S12DT256 MCU installed on the CSM12D module, expanded mode operation is supported and available to the user. All signals necessary to implement the multiplexed bus are available at connector J1.

The MODE option header is used to configure the module for expanded bus mode operation. Refer to the 9S12DT256 Device User Guide for details on implementing the expanded bus.

MODE

By default, the MC9S12XDT512 and MC9S12DT256 MCU's are configured for single-chip operation. The MODE option header allows the user to configure the board for expanded bus operation. In default configuration, this header is not installed in default configurations.

Figure 2: MODE Option Header

MODB 3 4 Shunt pulls MODB input high MODA 1 2 Shunt pulls MODA input high MODE

NOTE: Expanded bus mode operation is supported only when a 9S12DT256 MCU is installed on the MCU.

POWER

The CSM12D is designed to be used with and powered from the MCUSLKA. The CSM12D will source power from the MCUSLKA through connector J1. The module may also be used as a stand-alone platform. As a stand-alone platform, the module may be powered through the 2.1mm barrel connector and on-board regulator or through connector J1. The module may also be configured to provide power to external circuitry connected to J1. When powering external circuitry, do not exceed the maximum output current limit of the on-board regulator.

The on-board voltage regulator (VR1) accepts power input through a 2.1mm barrel connector (PWR). Input voltage may range from +7V to +18V. The voltage regulator (VR1) provides a +5V fixed output voltage with current output limited to 250mA. Over-temperature and over-current limit built into the voltage regulator provides protection from excessive stresses. Do not exceed the maximum output current limit of VR1 when attempting to power off-board circuitry through connector J1.

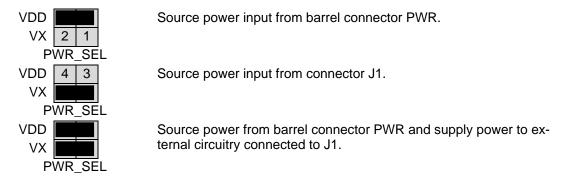
POWER SELECT

Power may be applied to the board through a 2.0mm barrel connector, or through connector J1. Optionally, power may be routed through connector J1 to supply external circuitry. Power selection is achieved by using a 4-pos selection header. When attached to the MCUSLKA, power is provide by the project board through connector J1.

Use caution when configuring this selection header. Applying power to the module through the on-board regulator and connector J1 at the same time may cause damage to the module.

PWR_SEL

Figure 3: PWR_SEL Option Header



NOTE: Exercise caution when configuring this selection header. Improper configuration may damage the module.

RESET SWITCH

The RESET switch provides a method to apply an asynchronous RESET to the MCU. The RESET switch is connected directly to the RESET* input on the MCU. Pressing the RESET switch applies a low voltage level to the RESET* input. Pressing the reset switch causes the reset supervisor at LV1 to assert RESET for 150 ms. A pull-up bias resistor allows normal MCU operation. Shunt capacitance ensures an adequate input pulse width.

LOW VOLTAGE RESET

A DS1813, low-voltage supervisor at LV1 protects the CSM12D under-voltage conditions. LV1 will assert RESET when the 5V rail falls below the trip point of 4.62V. LV1 will asserted RESET for approximately 150ms after voltage returns to nominal.

TIMING

Timing input to the MCU is provided by a 4 MHz, fundamental frequency, crystal oscillator. The oscillator exhibits a frequency tolerance of ±30ppm. The timing input is configured for full-swing Pierce mode operation in both MCU configurations.

The XCLKS output is routed to test point VIA located near the MCU. The internal clock ECLKX2 is available at this via if needed. The user can also use the XCLKS signal via to configure the 9S12XDT512 for low-power Pierce mode timing input. Refer to the 9S12XDT512 Device User Guide for details.

COMMUNICATIONS

The CSM12D module provides the user with 1 COM port and 1 CAN port on the module. COM1 is links to SCI0 on the MCU. The RS-232 channel is configured as a DCE device. This allows a straight through cable between the module and the host PC.

Both MCU's provide 2 additional CAN ports, 3 SPI ports, and 1IIC port. Access to these communications ports is provided through connector J1. Physical layer support is not provide for these feature and must be provided by the user in needed. Refer to the MCU Device User Guide for details

RS-232

An RS-232 translator provides RS-232 to TTL/CMOS logic level translation on the COM connector. The COM connector is a 9-pin Dsub, right-angle connector. A ferrite bead on shield ground provides conducted immunity protection. Communication signals TXD and RXD are routed from the transceiver to the MCU. Communications signals TXD and RXD also connect to general purpose Port S signals on the MCU.

Table 5: COM Connections

MCU Port	COM Signal	I/O PORT CONNECTOR
PS1/TXD0	TXD0	J1-5
PS0/RXD0	RXD1	J1-7
PS3/TXD1	TXD1	J1-40
PS2/RSXD1	RXD1	J1-38

Communications signals Tx/Rx route to connector J1 for use off-module if desired. When using these signal to drive off-module RS-232 devices or when attempting alternate communications protocols such at IrDA or LIN, the user should disconnect the on-board RS-232 transceiver. The COM_EN header block allows the user to selectively disable each of the 4 communications signals.

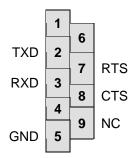
Figure 4: COM_EN Header

1 2 TX Enable/Disable TX to transceiver
3 4 RX Enable/Disable RX to transceiver
COM EN

COM Connector

A standard 9-pin Dsub connectors provide external connection for COM1. The Dsub shell is connected to board ground through a ferrite bead. The ferrite bead provides noise isolation on the RS-232 connection. The figure below details the DB9 connector.

Figure 5: COM Connector



Female DB9 connector that interfaces to the MCU internal SCI0 serial port via the RS232 transceiver. It provides simple 2 wire asynchronous serial communications without flow control. Flow control is provided at test points on the board. A straight-through cable is used to connect the module to a DTE device such as a host PC.

Pins 1, 4, and 6 are connected together. Pins 7 and 8 are connected together.

MSCAN

The CSM12D provides one PCA82C250 high-speed CAN physical interface. A 3-pin connector provides connectivity to the off-board CAN bus. The CAN PHY connects to the CAN0 channel on the MCU. The PHY supports data rates up to 1 Mbps with slew-rate control. The figure below shows the pin-out of the CAN_PORT connector.

Figure 6. CAN_PORT Connector

1	CAN_H	The CAN PHY connects to the CAN0
2	GND	channel in the MCU
3	CAN L	

Both MCU's provide support for additional CAN channels. All CAN channels supported are routed to the connector J1 for use if needed. Consult the Device User Guide for the installed MCU for further details.

VRH/VRL

MCU inputs VRH and VRL provide the upper and lower voltage reference for the analog to digital (ATD) converter. By default, VRH is tied to VDD and VRL is tied to ground. Adequate filtering has been added to provide a voltage reference with minimal ripple. Either, or both, references may be isolated to provide alternate ATD input references. A test point via on each signal, labeled VRH, or VRL, provides an easy way to attach an alternate reference voltage.

A 0-ohm configuration resistor allows isolation of each reference voltage. Removing R10 isolates VRH while removing R12 isolates VRL. Install a suitably sized 0-ohm resistors in these locations to restore the board to its default configuration.

Care must be exercised when using alternate input references. The associated configuration resistor must be removed before applying an alternate voltage reference or the board may be damaged. Also, no input protection is provided; incorrect configuration will damage the MCU. The table below summarizes the changes necessary to use alternate VRH and/or VRL.

Table 6: ATD Reference Voltage

	Installed (Default)	Removed
R4 VRH = VDD		VRH provided by user
R5 VRL = GND		VRL provided by user

NOTE: Damage to the board may result if an alternate reference voltage is attached without first removing the associated configuration resistor.

USER I/O

User I/O includes 2 push button switches, one 4-position DIP switch, 4 green LEDs, a potentiometer, and a photo-sensor. The sections below provide details on each User I/O. The User option header block enables or disables each User I/O individually.

Switches

The CSM12D target board provides 2 push button switches and one 4-position DIP switch for user input. Each push button switch is an active low input with a pull-up resistor bias to prevent indeterminate input conditions. Pressing a push-button switch causes a low logic input on the associated input.

Each DIP switch position is an active low input. Use of the DIP switches requires enabling the associated PORTB pull-ups internal to the MCU prevent indeterminate input conditions. Moving a DIP switch position to ON causes a low logic level on the associated input. Table 7 shows the associated connection signal for each switch. Table 8 shows the associated USER enable position to enable each switch.

LED's

The CSM12D target board provides 4 green LEDs for output indication. Each LED is an active low output. A current-limit resistor prevents excessive diode current. Writing a low logic level to an LED output causes the associated LED to turn on. Table 7 shows the associated connection signal for each LED. Table 8 shows the associated USER enable position to enable each LED.

POT

A single-turn, 3/8 inch, 5K ohm trimmer potentiometer (POT) has been provided as user, analog input. The part is decoupled to minimize noise during adjustment. The POT connects to

analog input PAD05/AN05 on the MCU. Table 7 shows the associated connection signal for the POT. Table 8 shows the associated USER enable position to enable the POT.

Photo-Sensor

A 4mm photocell light sensor exhibiting 23K – 33K ohms of output resistance has been provided. Output resistance is inversely related to incident light intensity. A gain stage (U5) amplifies the sensor output before connecting to the MCU. The SENSOR connects to analog input PAD04/AN04 on the MCU. Table 7 shows the associated signal connection for the sensor. Table 8 shows the associated USER enable position to enable the sensor.

Signals

The following table shows the connections for each user I/O device.

Table 7: User I/O

USER	Ref Des	Signal	Device
1	SW1	PP0/KWP0/PWM0/MISO1	Push Button Switch
2	SW2	PP1/KWP1/PWM1/MOSI1	Push Button Switch
3	SW3-1	PB0/ADDR0/DATA0	4-pos DIP Switch
4	SW3-2	PB1/ADDR1/DATA1	4-pos DIP Switch
5	SW3-3	PB2ADDR2/DATA2	4-pos DIP Switch
6	SW3-4	PB3/ADDR3/DATA3	4-pos DIP Switch
7	LED1	PB4/ADDR4/DATA4	Green LED
8	LED2	PB5/ADDR5/DATA5	Green LED
9	LED3	PB6/ADDR6/DATA6	Green LED
10	LED4	PB7/ADDR7/DATA7	Green LED
11	RV1	PAD05/AN05	Potentiometer
12	RZ1	PAD04/AN04	Light Sensor

Enables

The User option header block enables or disables each User I/O device individually. User I/O includes 4 green LEDs, 2 push button switches, one 4-position DIP switch, a Light Sensor, and a potentiometer. Installing a shunt enables the associated option. Removing a shunt disables the associated option. The table below shows the configuration option for each USER I/O.

Table 8: USER Option Header

			Shunt		
	USER		Installed	Removed	Description
SW1	1	2	Enable	Disable	Push Button Switch 1
SW2	3	4	Enable	Disable	Push Button Switch 2
SW3-1	5	6	Enable	Disable	DIP Switch Position 1
SW3-2	7	8	Enable	Disable	DIP Switch Position 2
SW3-3	9	10	Enable	Disable	DIP Switch Position 3
SW3-4	11	12	Enable	Disable	DIP Switch Position 4
LED1	13	14	Enable	Disable	LED 1
LED2	15	16	Enable	Disable	LED 2
LED3	17	18	Enable	Disable	LED 3
LED4	19	20	Enable	Disable	LED 4
RV1	21	22	Enable	Disable	Potentiometer
RZ1	23	24	Enable	Disable	Light Sensor

MCU I/O PORT

Connector J1 provides access to the MC9S12XDT512 and MC9S12DT256 I/O signals. The figures below show the pin-out for the MCU I/O connector. Only signal XCLS is not available at connector J1.

Figure 7: Connector J1

V_{AUX}	1 2	PE1/IRQ*
GND	3 4	RESET*
PS1/TXD0	5 6	MODC/BKGD
PS0/RXD0	7 8	PP7/KWP7/PWM7/SCK2
PP0/KWP0/PWM0/MISO1	9 10	PAD07/AN07
PP1/KWP1/PWM1/MOSI1	11 12	PAD06/AN06
PT0/IOC0	13 14	PAD05/AN05
PT1/IOC1	15 16	PAD04/AN04
PM4/RXCAN2/RXCAN0/RXCAN4/MOSI0	17 18	PAD00/AN00
PM2/RXCAN1/RXCAN0/MISO0	19 20	PAD01/AN01
PM5/TXCN2/TXCAN0/TXCAN4/SCK0	21 22	PAD02/AN02
PM3/TXCAN1/TXCAN0/SS0*	23 24	PAD03/AN03
PA7/ADDR15/DATA15	25 26	PJ7/KWJ7/TXCAN4/SCL0
PA6/ADDR14/DATA14	27 28	PJ6/KWJ6/RXCAN4/SDA0
PA5/ADDR13/DATA13	29 30	PP2/KPP2/PWM2/SCK1
PA4/ADDR12/DATA12	31 32	PP3/KWP3/PWM3/SS1*
PA3/ADDR11/DATA11	33 34	PP4/KWP4/PWM4/MISO2
		PP5/KWP5/PWM5/MOSI2
PA1/ADDR9/DATA9	37 38	PS2/RXD1
PA0/ADDR8/DATA8		
PB7/ADDR7/DATA7		
PB6/ADDR6/DATA6		-
PB5/ADDR5/DATA5	45 46	PE3/LSTRB*
PB4/ADDR4/DATA4		
PB3/ADDR3/DATA3		
PB2/ADDR2/DATA2		
PB1/ADDR1/DATA1		
PB0/ADDR0/DATA0		
PM1/TXCAN0/TXB		
PM0/RXCAN0/RXB	59 60)[P17/IOC7

NOTE: Expanded bus functions (in italics) are not available on the XDT512 derivative.